

2RB-8 Series

Description

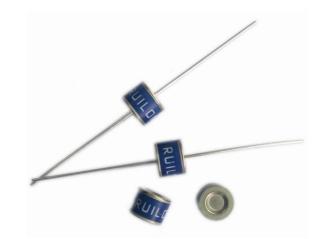
GDT is placed in front of, and in parallel with, sensitive telecom equipment such as power lines, communication lines, signal lines and data transmission lines to help protect them from damage caused by transient surge voltages that may result from lightning strikes and equipment switching operations. These devices do not influence the signal in normal operation. However, in the event of an overvoltage surge, such as a lightning strike, the GDT switches to a low impedance state and diverts the energy away from the sensitive equipment.

Our GDT offer a high level of surge protection, a broad voltage range, low capacitance, and many form factors including new surface mount devices, which makes them suitable for applications such as Main Distribution Frame (MDF) modules, high data-rate telecom applications (e.g. ADSL, VDSL), and surge protection on power lines. Their low capacitance also results in less signal distortion. When used in a coordinated circuit protection solution with PolySwitch devices, they can help equipment manufacturers meet stringent safety regulatory standards.

Features

- I Excellent response to fast rising transients
- I Stable breakdown voltage
- I GHz working frequency
- I 8/20µs Impulse current capability: 10KA
- I Non-Radioactive
- I Ultra Low capacitance (<1.5pF)
- I Lead-free compliant
- I RoHS and REACH compliant
- I UL 497B Recognized: E465335
- I Size: Φ8mm*6mm
- I Storage and operational temperature: -40~+90°C

Part Number Code

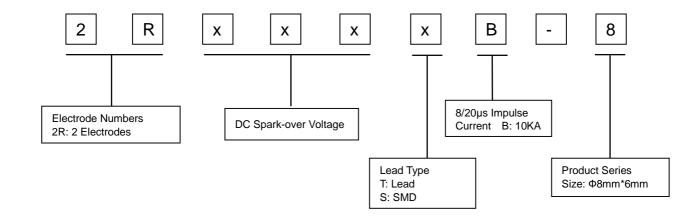


Electrical symbol



Applications

- I MDF modules
- I xDSL equipment
- I RF systems
- I Antenna
- I Base stations
- I Repeaters, Modems
- I Telephone Interface, Line cards
- I Data communication equipment
- I Line test equipment
- I Power supplies
 - Surge protectors, Alarm systems



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2RB-8 Series

Electrical Characteristics

Part Number		DC Spark-over Voltage ^{1) 2)} @100V/S	Impulse Spark-over Voltage		Insulation Resistance	Capacitance @1MHz	Life Ratings			
							Impulse Discharge Current		AC Discharge Current	Impulse Life @10/1000µS
			100V/µS	S 1KV/µS	0,		@8/20µS		@50Hz 1S	100A
			Max	Max	Min	Мах	Nominal ±5 times	Max 1 time	Nominal 5 times	Min
DIP	SMD	v	v	v	GΩ	pF	KA	KA	Α	Times
2R075TB-8	2R075SB-8	75±20%	500	600	1	1.5	10	20	10	300
2R090TB-8	2R090SB-8	90±20%	500	600	1	1.5	10	20	10	300
2R150TB-8	2R150SB-8	150±20%	500	600	1	1.5	10	20	10	300
2R230TB-8	2R230SB-8	230±20%	600	700	1	1.5	10	20	10	300
2R250TB-8	2R250SB-8	250±20%	600	700	1	1.5	10	20	10	300
2R300TB-8	2R300SB-8	300±20%	750	850	1	1.5	10	20	10	300
2R350TB-8	2R350SB-8	350±20%	800	900	1	1.5	10	20	10	300
2R400TB-8	2R400SB-8	400±20%	850	950	1	1.5	10	20	10	300
2R420TB-8	2R420SB-8	420±20%	900	1000	1	1.5	10	20	10	300
2R470TB-8	2R470SB-8	470±20%	1000	1100	1	1.5	10	20	10	300
2R600TB-8	2R600SB-8	600±20%	1000	1200	1	1.5	10	20	10	300
2R800TB-8	2R800SB-8	800±20%	1400	1600	1	1.5	10	20	10	300
Glow Voltage at	10mA				~60V					
Arc Voltage at 1	A				~10V					
Glow to Arc tran	sition Current				~0.5A					
Weight			DIP ~ SMD ~	-1.5g -1.25g						
Operation and s	torage temperatu	ure			40~+90	°C				
Climatic category (IEC 60068-1)			40/90/2	1						
Marking, blue negative			XXX	NXXX Y Nominal voltag	-					
Surface treatme	nt					Nickel Plated Matte-tin plated	ł			

 $^{\rm 2)}$ In ionized mode

³⁾ Insulation Resistance Measuring Voltage:

75V at DC 25V

90V~150V at DC 50V

Other at DC 100V

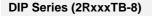
Terms in accordance with ITU-T Rec. K.12, IEC 61643-311, GB/T 9043.

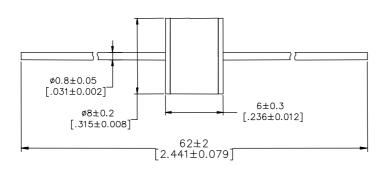
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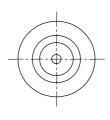


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Dimensions (Unit: mm/inch)







1.5 [.059]

6

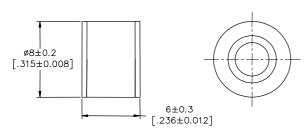
[.236]

Recommended Soldering Pad Layout

8 [.315]

275±2 [10.827±0.079]

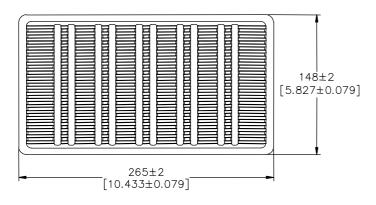
SMD Series (2RxxxSB-8)



Packaging Information (Unit: mm/inch)

Axial Packaging (Bulk)

Plastic Tray



Packaging Quantity:

100 PCS per Plastic Tray

5 Plastic Trays per inner box

500 PCS per inner box

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Inner box

150±2 [5.906±0.079]

50±1 [1.969±0.039]

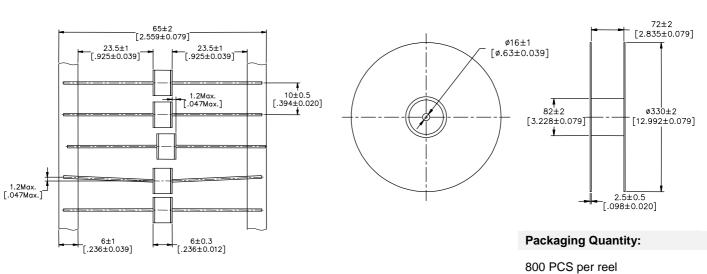
Reel

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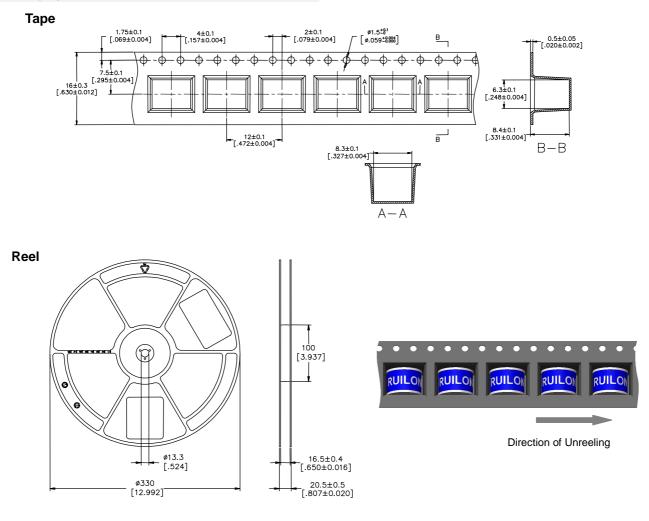
Axial Packaging (Tape & Reel)

Таре

ELECTRONICS



SMD Packaging (Tape & Reel)



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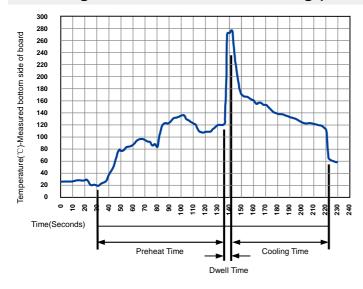
Inner box ³³⁵ ^{13.189]} ⁷⁰ ⁷⁰ ⁷⁰ ⁷⁰ ⁷⁰ ⁷⁰

Packaging Quantity: 500 PCS per reel (13") 3 reels per inner box

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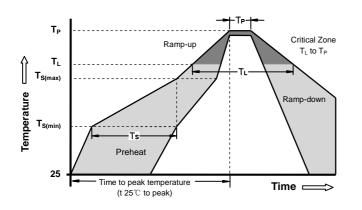
1,500 PCS per inner box

Soldering Parameters - Wave soldering (Thru-Hole Devices)



Wave Soldering Condition		Pb-Free assembly
Preheat	Temperature Min	100°C
	Temperature Max	150°C
	Time (Min to Max)	60-180 Seconds
Solder Pot Temperature		280°C Max
Solder Dwell Time		2-5 Seconds

Soldering Parameters - Reflow Soldering (Surface Mount Devices)



Reflow Condition		Pb - Free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Preheat	-Temperature Max (T _{s(max)})	200°C		
	- Time (min to max) (t _s)	60 -180 Seconds		
Average ramp up rate (Liquids Temp T _L) to peak		3°C/second max		
T _{S(max)} to TL - Ramp-up Rate		5°C/second max		
Reflow	 Temperature (T_L) (Liquids) 	217°C		
	- Time (min to max) (t_s)	60 -150 Seconds		
Peak Temperature (T _P)		260 +0/-5°C		
Time with Temperate	in 5°C of actual peak ure (t _p)	10 - 30 Seconds		
Ramp-dov	vn Rate	6°C/second max		
Time 25°C	to peak Temperature (T _P)	8 minutes Max		
Do not ex	ceed	260°C		

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Specifications are subject to change without notice. Please refer to http://www.ruilon.com.cn for current information.